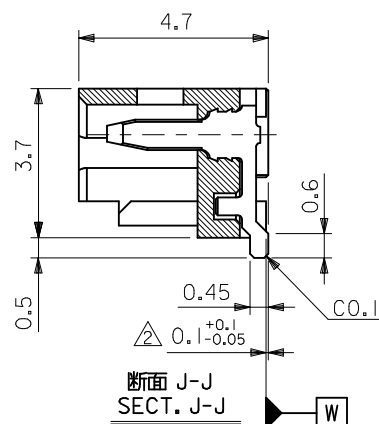
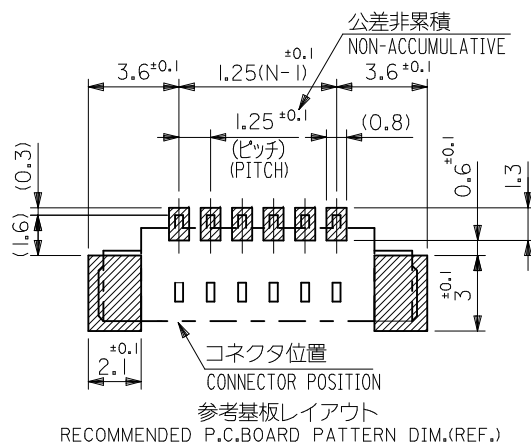
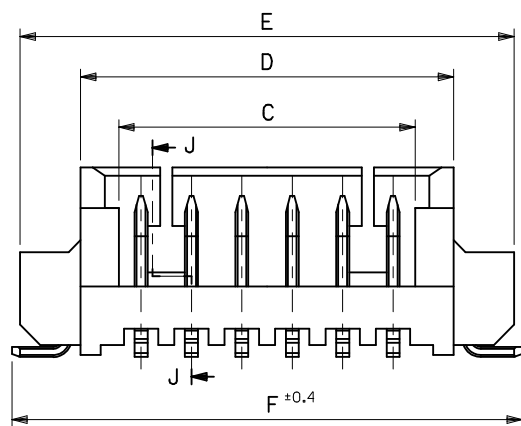
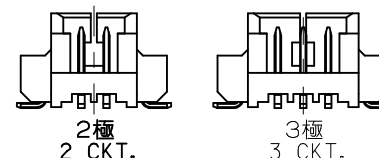




注記 NOTES

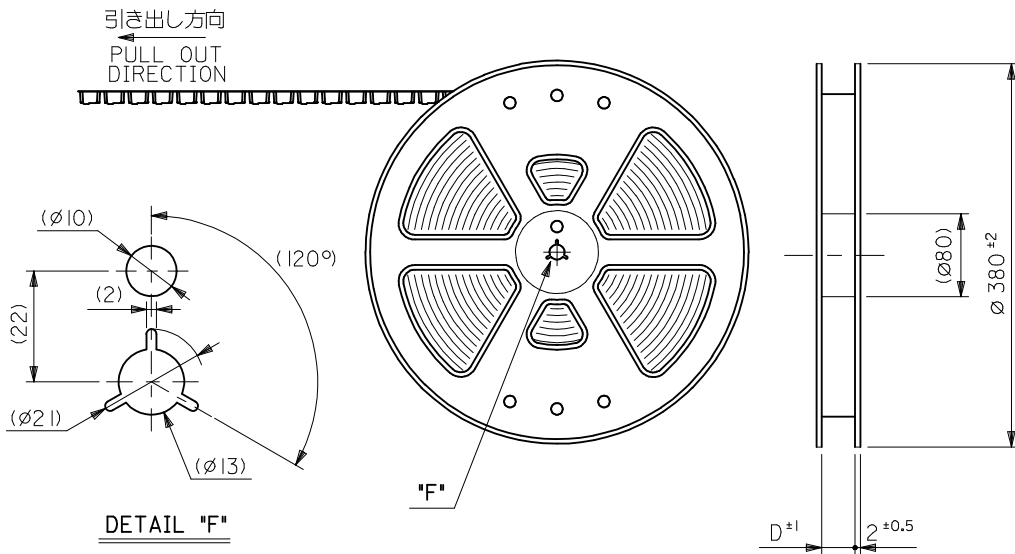
1. 嵌合相手: 51021シリーズ MATE WITH: 51021 SERIES
- △ 水平面上において、ウエハー底面 **W** とソルダーテール及び
フィッティングネイル底面とのズレ量を示す。
MISALIGNMENT OF SOLDER TAIL & FITTING NAIL FROM **W**
- △ 偶数極にのみ適用。APPLY EVEN CIRCUIT PRODUCTS.
- △ ロック窓は、2、3極は1ヶ所、4極以上は2ヶ所とする。
LOCKING WINDOW: ONE PLACE FOR 2&3 CKTS.
TWO PLACES FOR MORE THAN 4 CKTS.
5. 材質 MATERIAL LEAD, UL94V-0 COLOR:NATURAL
ウエハー :
WAFER
ピン : リン青銅
PIN : PHOS-BRO
: 錫メッキ 1.0マイクロメートル以上
: MATTE TIN 1.0 MICROMETER MINIMUM
: ニッケル下地 1.0マイクロメートル以上
: NICKEL(UNDER PLATING)1.0 MICROMETER MINIMUM
金具 : リン青銅
FITTING NAIL : PHOS-BRO
: 錫メッキ 1.0マイクロメートル以上
: MATTE TIN 1.0 MICROMETER MINIMUM
: ニッケル下地 1.0マイクロメートル以上
: NICKEL(UNDER PLATING)1.0 MICROMETER MINIMUM
6. 本製品は 53398-**10 の鉛フリー品である。
THIS PRODUCT IS LEAD FREE OF 53398-***10.



△4 ロック形状図

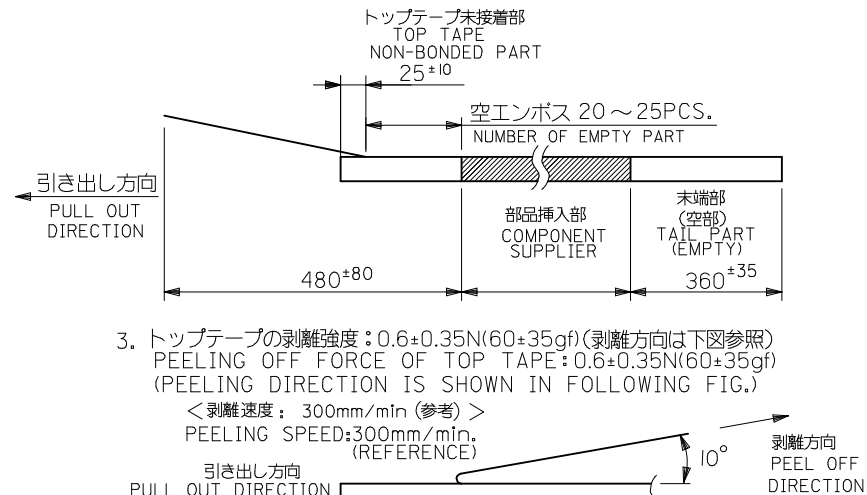
REVISED	EC NO: J2010-0213	2009/09/25 DRWN:TKON 2009/09/25 CHKD:NUKITA 2009/09/28 APPR:NUKITA	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC		THIRD ANGLE PROJECTION	
				10 UNDER	± 0.2	DRAWN BY MNI NOMIYA	DATE 04/02/06	TITLE 1.25 W/B CONN. ASS'Y FOR SMT(ST.) -LEAD FREE-				
				10 OVER 30 UNDER	± 0.25	CHECKED BY KTOJO	DATE 04/02/06					
				30 OVER	± 0.3	APPROVED BY MSASAO	DATE 04/02/06					
				ANGULAR ±3 °		MATERIAL NO.		DOCUMENT NO.		SHEET NO.		
				DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE SHEET 2		SD-53398-032				1 OF 2
				REV				SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			

[illegible]

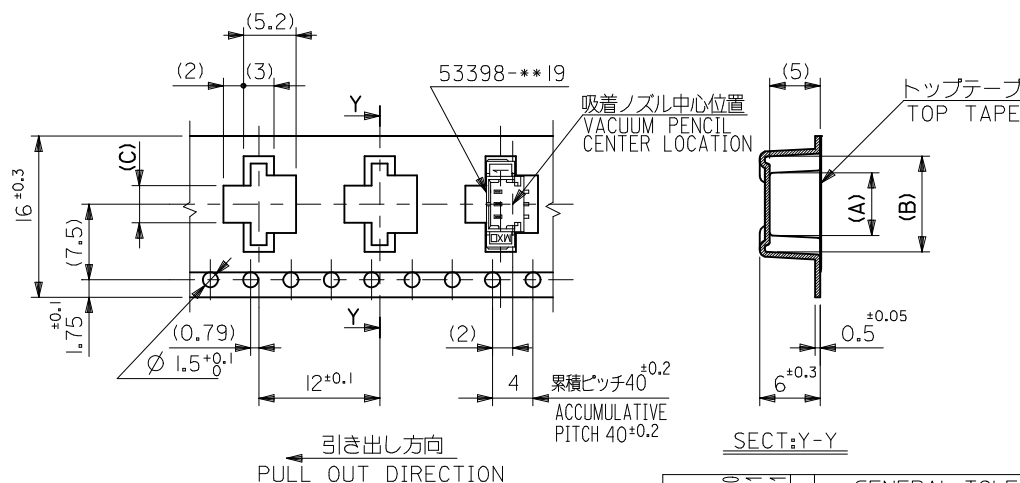


NOTES

- 梱包数量: 1000個/リール
NUMBER OF CONNECTOR: 1000PCS/REEL
- リードテープ長さ
LEAD TAPE LENGTH



- トップテープの剥離強度: 0.6 ± 0.35N (60 ± 35gf) (剥離方向は下図参照)
PEELING OFF FORCE OF TOP TAPE: 0.6 ± 0.35N (60 ± 35gf)
(PEELING DIRECTION IS SHOWN IN FOLLOWING FIG.)
剥離速度: 300mm/min (参考) >
PEELING SPEED: 300mm/min. (REFERENCE)
- 53398-**-19 の詳細寸法については図面 SD-53398-032 を参照下さい。
RE DETAILED DIMENSIONS, SEE SD-53398-032.
- 材料 (MATERIAL)
キャリアテープ (CARRIER TAPE): ポリプロピレン (POLYPROPYLENE)
トップテープ (TOP TAPE): PET, PE, PEF
リール (REEL): ポリスチレン (P.S.) <リサイクル材含む>
POLYSTYRENE (P.S.) <RECYCLE MATERIAL CONTAINED>
- 本製品は 53398-**-90 の鉛フリー品である。
THIS PRODUCT IS LEAD FREE OF 53398-**-90.
- 本製品は乾燥剤入り、ハイバリア梱包仕様である。
THIS PRODUCT IS HIGH BARRIER PACKAGE WITH DESICCANT.



16	21.4	17.4	3.7	9.5	5.8	53398-0371	3
キャリアテープ幅 CARRIER TAPE WIDTH	E	D	2.45	8.25	4.55	53398-0271	2
			(C)	(B)	(A)	MATERIAL NO.	極数 CKT.

REVISED EC NO.: J2009-2060 DRAWN: IKON CHKD: MATSUMOTO APPR: NUKITA	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
		10 UNDER	± 0.2	NINOMIYA	'04/02/06	TITLE 1.25 W/B CONN WAFER ASSY FOR SMT. EMBSTP. PKG. -LEAD FREE-	MOLEX MOLEX INCORPORATED	SHEET NO. 1 OF 3	
		10 OVER 30 UNDER	± 0.25	CHECKED BY K. TOJO	DATE '04/02/06				
		30 OVER	± 0.3	APPROVED BY M. SASAO	DATE '04/02/06				
		ANGULAR ±3 °		MATERIAL NO.		DOCUMENT NO.			
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE TABLE & SHEET 2.3		SD-53398-033				
	REV			SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				

10 9 8 7 6 5 4 3 2 1

F

E

D

C

B

A

F

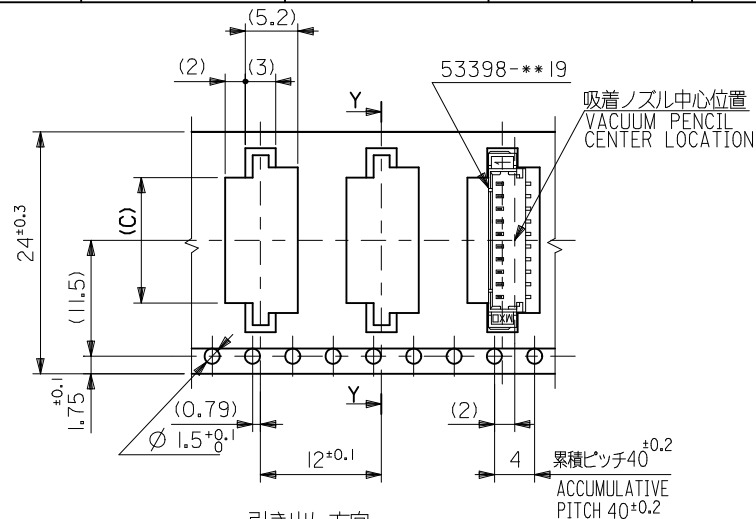
E

D

C

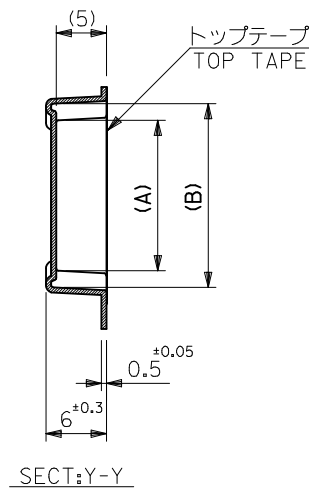
B

A

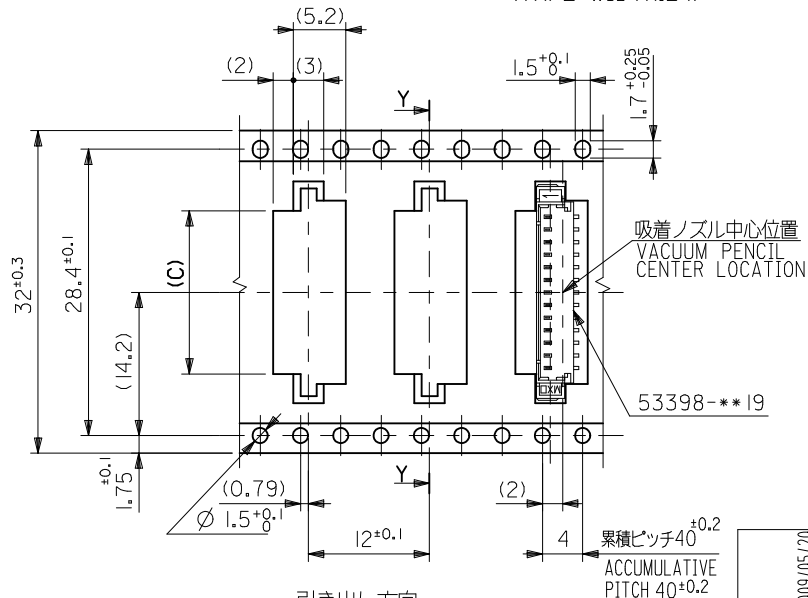


引き出し方向
PULL OUT DIRECTION

24幅テープ
(TAPE WIDTH:24)

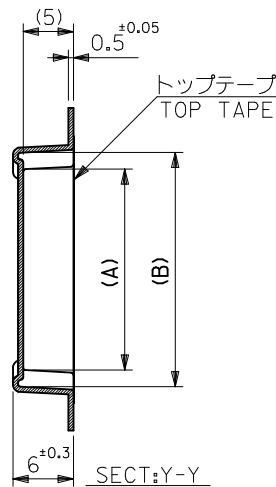


SECT:Y-Y



引き出し方向
PULL OUT DIRECTION

32幅テープ
(TAPE WIDTH:32)



SECT:Y-Y

32	37.4	33.4	16.2	22	18.3	53398-1371	13	
			14.95	20.75	17.05	▲ -1271	12	
			13.7	19.5	15.8	▲ -1171	11	
24	29.4	25.4	12.45	18.25	14.55	▲ -1071	10	
			11.2	17	13.3	▲ -0971	9	
			9.95	15.75	12.05	▲ -0871	8	
			8.7	14.5	10.8	▲ -0771	7	
			7.45	13.25	9.55	▲ -0671	6	
			6.2	12	8.3	▼ -0571	5	
			4.95	10.75	7.05	53398-0471	4	
			キャリアテープ幅 CARRIER TAPE WIDTH		E	D	(C)	(B)

REVISED EC NO: J2009-2060 DRWN:TKN CHKD:HMATSUMOTO APPR:NUKITA REV	DESCRIPTION 2009/05/20 2009/05/21 2009/05/21	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	± 0.2	DRAWN BY NINOMIYA	DATE '04/02/06	TITLE 1.25 W/B CONN WAFER ASSY FOR SMT. EMBSTP. PKG. -LEAD FREE-				
		10 OVER 30 UNDER	± 0.25	CHECKED BY K. TOJO	DATE '04/02/06					
		30 OVER	± 0.3	APPROVED BY M. SASAO	DATE '04/02/06					
		ANGULAR ±3 °		MATERIAL NO.		DOCUMENT NO.		SHEET NO.		
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE TABLE & SHEET 1.3		SD-53398-033		2 OF 3		
				SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					

10 9 8 7 6 5 4 3 2 1

F

F

E

E

D

D

C

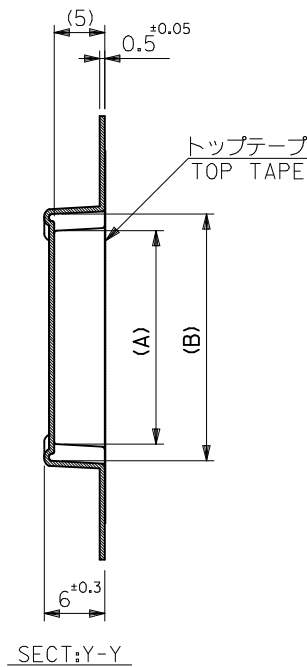
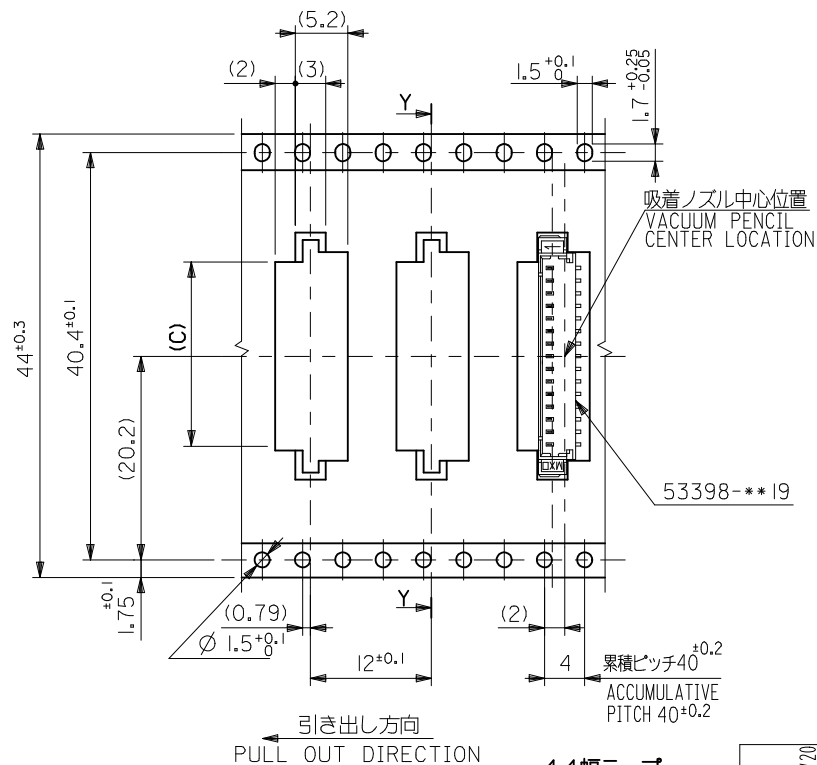
C

B

B

A

A



44幅テープ
(TAPE WIDTH:44)

44	49.4	45.4	18.7	24.5	20.8	53398-1571	15
キャリアテープ幅 CARRIER TAPE WIDTH	E	D	17.45	23.25	19.55	53398-1471	14
	(C)	(B)	(A)			MATERIAL NO.	極数 CKT.

REVISED EC NO.: J2009-2060 DRWN:TKON CHKD:HMATSUMOTO APPR:NUKITA	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	± 0.2	DRAWN BY NINOMIYA	DATE '04/02/06	TITLE 1.25 W/B CONN WAFER ASSY FOR SMT. EMBSTP. PKG. -LEAD FREE-				
		10 OVER 30 UNDER	± 0.25	CHECKED BY K. TOJO	DATE '04/02/06					
		30 OVER	± 0.3	APPROVED BY M. SASAO	DATE '04/02/06	MOLEX INCORPORATED				
		ANGULAR ±3 °		MATERIAL NO.		DOCUMENT NO.		SHEET NO.		
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE TABLE & SHEET 12		SD-53398-033		3 OF 3		
	REV B		SIZE A3 THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							